



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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**I18/2/10**

Ferrite core

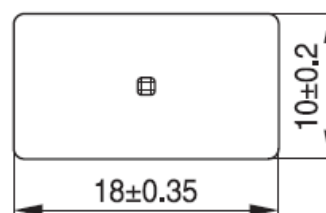
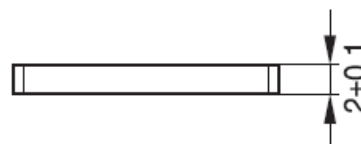
<b>Series/Type:</b>	<b>B66453</b>
<b>Ordering code:</b>	<b>B66453K0000X608</b>
Date:	2017-07-25
Version:	3

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**Magnetic characteristics (per set; combination ELP 18/4/10 + I18/2/10)**

$$\begin{aligned} \Sigma l/A &= 0.51 \text{ mm}^{-1} \\ l_e &= 20.3 \text{ mm} \\ A_e &= 39.5 \text{ mm}^2 \\ A_{\min} &= 38.9 \text{ mm}^2 \\ V_e &= 802 \text{ mm}^3 \end{aligned}$$



non contact surface

**Approx. weight**

4.1 g/set

**Delivery mode**

In pieces

**Packing**

Standard Styrofoam Tray (size 200 mm × 300 mm)

Material	$A_L$ value <sup>1)</sup> nH	$\mu_e$	$P_{V_{\max}}$ W/Set	Ordering code Without clamp recess
PC200	1500 ±25%	610	< 0.25 (1000 kHz, 50 mT, 100 °C) < 0.3 (2000 kHz, 30 mT, 100 °C)	B66453K0000X608
	1900 ±25% <sup>2)</sup>	780	< 0.35 (1000 kHz, 50 mT, 100 °C) <sup>2)</sup> < 0.75 (2000 kHz, 30 mT, 100 °C) <sup>2)</sup>	

1) Measurement Parameter: 10 kHz, 0.25 mT, 100 turns, room temperature.

 $A_L$  value is measured acc. to IEC62044-2. An appropriate wringing of cores with polished surface is used to improve reproducibility of the measurement. (It is recommended to rub the mating surfaces themselves six times in a circular or elliptic arc that matches the core profile before measuring  $A_L$  value).

 2) Magnetised (magnetised in DC field strength  $H = 200 \text{ A/m}$  for 10 s)

Material PC200 is not suitable for applications with strong magnetic fields above 80 A/m.

With respect to power loss characteristics, customer should assure, that there is no overheating in an application.

For information only.

## Cautions and warnings

### Mechanical stress and mounting

Ferrite cores have to meet mechanical requirements during assembling and for a growing number of applications. Since ferrites are ceramic materials one has to be aware of the special behavior under mechanical load.

As valid for any ceramic material, ferrite cores are brittle and sensitive to any shock, fast temperature changing or tensile load. Especially high cooling rates under ultrasonic cleaning and high static or cyclic loads can cause cracks or failure of the ferrite cores.

For detailed information see data book, chapter "*General - Definitions, 8.1*".

### Effects of core combination on AL value

Stresses in the core affect not only the mechanical but also the magnetic properties. It is apparent that the initial permeability is dependent on the stress state of the core. The higher the stresses are in the core, the lower is the value for the initial permeability. Thus the embedding medium should have the greatest possible elasticity.

For detailed information see data book, chapter "*General - Definitions, 8.1*".

### Heating up

Ferrites can run hot during operation at higher flux densities and higher frequencies.

### NiZn-materials

The magnetic properties of NiZn-materials can change irreversible in high magnetic fields.

### Ferrite Accessories

EPCOS ferrite accessories have been designed and evaluated only in combination with EPCOS ferrite cores. EPCOS explicitly points out that EPCOS ferrite accessories or EPCOS ferrite cores may not be compatible with those of other manufacturers. Any such combination requires prior testing by the customer and will be at the customer's own risk.

EPCOS assumes no warranty or reliability for the combination of EPCOS ferrite accessories with cores and other accessories from any other manufacturer.

### Processing remarks

The start of the winding process should be soft. Else the flanges may be destroyed.

- Too strong winding forces may blast the flanges or squeeze the tube that the cores can not be mounted any more.
- Too long soldering time at high temperature (>300 °C) may effect coplanarity or pin arrangement.
- Not following the processing notes for soldering of the J-leg terminals may cause solderability problems at the transformer because of pollution with Sn oxyde of the tin bath or burned insulation of the wire. For detailed information see chapter "*Processing notes*", section 2.2.
- The dimensions of the hole arrangement have fixed values and should be understood as a recommendation for drilling the printed circuit board. For dimensioning the pins, the group of holes can only be seen under certain conditions, as they fit into the given hole arrangement. To avoid problems when mounting the transformer, the manufacturing tolerances for positioning the customers' drilling process must be considered by increasing the hole diameter.

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